2SK3045

Silicon N-Channel Power F-MOS FET

Features

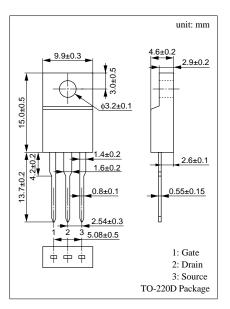
- Avalanche energy capacity guaranteed: EAS > 15.6mJ
- $V_{GSS} = \pm 30V$ guaranteed
- High-speed switching: $t_f = 35$ ns
- No secondary breakdown

Applications

- Contactless relay
- Diving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

Paramet	er	Symbol	Ratings	Unit	
Drain to Source breakdown voltage		V _{DSS}	500	V	
Gate to Source voltage		V _{GSS}	±30	V	
Drain current	DC	I _D	±2.5	А	
	Pulse	I _{DP}	±10		
Avalanche energy capacity		EAS*	15.6	mJ	
Allowable power	$T_C = 25^{\circ}C$	D	30	w	
dissipation	$Ta = 25^{\circ}C$	P _D	2		
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	-55 to +150	°C	

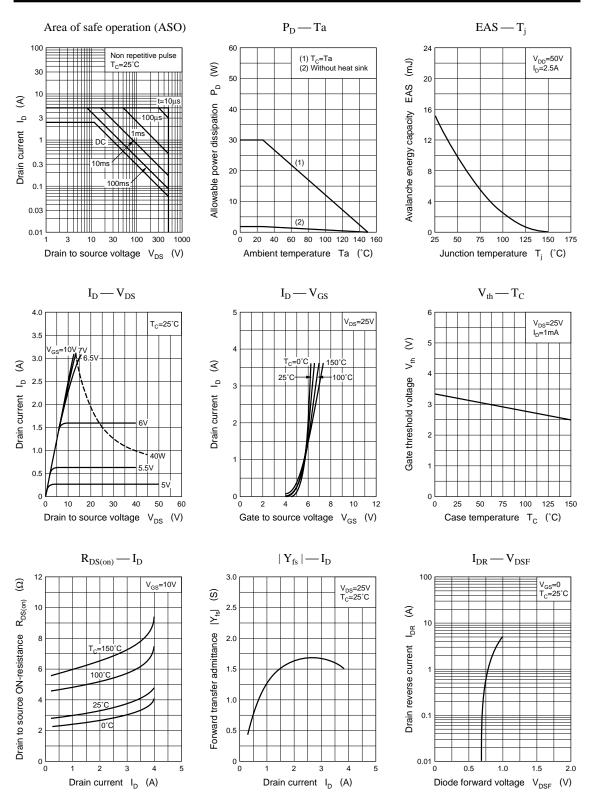
Absolute Maximum Ratings ($T_c = 25^{\circ}C$)



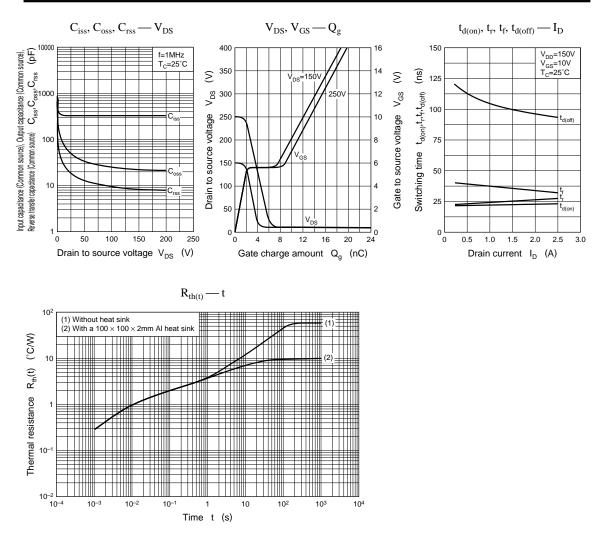
* L = 5mH, I_L = 2.5A, V_{DD} = 50V, 1 pulse

Electrical Characteristics ($T_C = 25^{\circ}C$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I _{DSS}	$V_{\rm DS} = 400 V, V_{\rm GS} = 0$			0.1	mA
Gate to Source leakage current	I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0$			±1	μΑ
Drain to Source breakdown voltage	V _{DSS}	$I_D = 1mA, V_{GS} = 0$	500			V
Gate threshold voltage	V _{th}	$V_{DS} = 25V, I_D = 1mA$	2		5	V
Drain to Source ON-resistance	R _{DS(on)}	$V_{GS} = 10V, I_D = 1.5A$		3.2	4	Ω
Forward transfer admittance	Y _{fs}	$V_{DS} = 25V, I_D = 1.5A$	1	1.5		S
Diode forward voltage	V _{DSF}	$I_{DR} = 2.5A, V_{GS} = 0$			-1.5	V
Input capacitance (Common Source)	C _{iss}			330		pF
Output capacitance (Common Source)	C _{oss}	$V_{DS} = 20V, V_{GS} = 0, f = 1MHz$		55		pF
Reverse transfer capacitance (Common Source)	C _{rss}			20		pF
Turn-on time (delay time)	t _{d(on)}			15		ns
Rise time	t _r	$V_{GS} = 10V, I_D = 1.5A$		25		ns
Turn-off time (delay time)	t _{d(off)}	$V_{DD} = 150V, R_L = 100\Omega$		55		ns
Fall time	t _f			30		ns



Power F-MOS FETs



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